PCN Number:		20200409000			PCN Date:		May 1, 2020		
Title: Datasheet for ISO7220A-Q1, ISO7221A-Q1, ISO7221C-Q1									
Customer Contact:			PCN Manager				Dep	ot:	Quality Services
Proposed 1 <sup>st</sup> Ship Date:			Nov 1	Nov 1, 2020					
Change Type:									
Assembly Site			Design				Wafer Bump Site		
Assembly Process				🛛 Data Sheet				Wafer	Bump Material
Assembly Materials				Part number change			Wafer	Bump Process	
Mechanical Specification			n in the second s	Test Site			Wafer	Fab Site	
Packing/Shipping/Labeling			ng	Test Process			Wafer	Fab Materials	
							Wafer	Fab Process	
Notification Details									
Description of Change:									
Texas Instruments Incorporated is announcing a change. The product datasheet(s) is being updated as summarized below.									
ISO7221A					ISO7220A-Q1 ISO7221A-Q1 ISO7221C-Q1 LY 2009-REVISED APRIL 2020				

	Made editorial and cosmetic changes throughout the document	1
	Change standard names From: 'IEC 60747-5-2 (VDE 0884, Rev 2), IEC 61010-1' To: 'DIN VDE V 0884-11:2017-01, DIN EN 61010-1' and add 'IEC 62368-1' in <b>FEATURES</b> .	1
	Updated REGULATORY INFORMATION table	
	Changed V <sub>1</sub> voltage rating From: '-0.5 V to 6 V' To: '-0.5 V to V <sub>cc</sub> + 0.5 V' in <b>ABSOLUTE MAXIMUM RATINGS</b> table	
	Added the following note to $V_1$ parameter: 'Maximum voltage must not exceed 6V' in <b>ABSOLUTE MAXIMUM</b> <b>RATINGS</b> table	
	Deleted typical values (TYP) for 'Input pulse width' and 'Signaling rate' specifications in RECOMMENDED OPERATING CONDITIONS table	
	Added 'Ambient temperature' specification in RECOMMENDED OPERATING CONDITIONS table	
	Changed 'Propagation delay' maximum (MAX) limit for ISO722xA From: 480 ns To: 600 ns in <b>SWITCHING</b> <b>CHARACTERISTICS</b> at $V_{CC1} = V_{CC2} = 5 \text{ V} \pm 10\%$ .	
•	Changed 'Pulse-width distortion' maximum (MAX) limit for ISO722xA From: 14 ns To: 18 ns in <b>SWITCHING</b> <b>CHARACTERISTICS</b> at $V_{CC1} = V_{CC2} = 5 \text{ V} \pm 10\%$ .	
	Changed 'ISO722xA' to 'ISO7220A' and deleted 'ISO722xC' row from 'Channel-to-channel output skew' specification in SWITCHING CHARACTERISTICS at $V_{CC1} = V_{CC2} = 5 \vee \pm 10\%$	
	Changed 'Propagation delay' maximum (MAX) limit for ISO722xA From: 480 ns To: 585 ns in SWITCHING CHARACTERISTICS at V <sub>cc1</sub> = 5 V ± 10%, V <sub>cc2</sub> = 3.3 V ± 10%	
•	Changed 'Pulse-width distortion' maximum (MAX) limit for ISO722xA From: 14 ns To: 18 ns in <b>SWITCHING</b> CHARACTERISTICS at V <sub>cc1</sub> = 5 V ± 10%, V <sub>cc2</sub> = 3.3 V ± 10%	
•	Changed 'ISO722xA' to 'ISO7220A' and deleted 'ISO722xC' row from 'Channel-to-channel output skew' specification in SWITCHING CHARACTERISTICS at $V_{CC1} = 5 \vee \pm 10\%$ , $V_{CC2} = 3.3 \vee \pm 10\%$	5
	Changed 'Propagation delay' maximum (MAX) limit for ISO722xA From: 480 ns To: 605 ns in SWITCHING CHARACTERISTICS at V <sub>cc1</sub> = 3.3 V ± 10%, V <sub>cc2</sub> = 5 V ± 10%	6
•	Changed 'Pulse-width distortion' maximum (MAX) limit for ISO722xA From: 18 ns To: 22 ns in <b>SWITCHING</b> CHARACTERISTICS at V <sub>cc1</sub> = 3.3 V ± 10%, V <sub>cc2</sub> = 5 V ± 10%	6
	Changed 'ISO722xA' to 'ISO7220A' and deleted 'ISO722xC' row from 'Channel-to-channel output skew' specification in SWITCHING CHARACTERISTICS at $V_{CC1}$ = 3.3 V ± 10%, $V_{CC2}$ = 5 V ± 10%	6
•	Changed 'Propagation delay' maximum (MAX) limit for ISO722xA From: 485 ns To: 610 ns in SWITCHING CHARACTERISTICS at V <sub>cc1</sub> = V <sub>cc2</sub> = 3.3 V ± 10%	7
•	Changed 'Pulse-width distortion' maximum (MAX) limit for ISO722xA From: 18 ns To: 22 ns in SWITCHING CHARACTERISTICS at $V_{CC1} = V_{CC2} = 3.3 \vee \pm 10\%$ .	7
	Changed 'ISO722xA' to 'ISO7220A' and deleted 'ISO722xC' row from 'Channel-to-channel output skew' specification in SWITCHING CHARACTERISTICS at $V_{CC1} = V_{CC2} = 3.3 \vee \pm 10\%$	7
•	Changed 'Tracking resistance' TEST CONDITIONS From: DIN IEC 60112 / VDE 0303 Part 1 To: DIN EN 60112 (VDE 0303-11) in IEC PACKAGE CHARACTERISTICS table	9
	Deleted 'IEC 60747-5-2' from INSULATIONS CHARACTERISTICS table title	9
	Added 'Maximum withstanding isolation voltage' specification of 2500 $V_{RMS}$ in INSULATION CHARACTERISTICS table	9
	Deleted 'e <sub>JC</sub> ' and 'per IEC 60747-5-2' from Figure 6 title.	

## The datasheet number will be changing.

Device Family	Change From:	Change To:			
ISO7220A-Q1, ISO7221A-Q1, ISO7221C-Q1	SLLS965C	SLLS965D			
These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/ISO7220A-Q1					
Reason for Change:					
To accurately reflect device characteristics.					
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):					
Electrical specification performance changes as indicated above.					

Changes to product identification resulting from this PCN:					
None.					
Product Affected:					
ISO7220AQDRQ1 ISO7221AQDRQ1		ISO7221CQDRQ1			

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